

ACP-1078

7" WSVGA Android Based Panel PC

User's Manual 1st Ed

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Preface II

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Preface III

Packing List

Before setting up your product, please make sure the following items have been shipped:

| Item | Quantity |
|------------|----------|
| • ACP-1078 | 1 |

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

Preface IV

About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the product page at AAEON.com for the latest version of this document.

Preface V

Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

- 1. All cautions and warnings on the device should be noted.
- All cables and adapters supplied by AAEON are certified and in accordance with
 the material safety laws and regulations of the country of sale. Do not use any
 cables or adapters not supplied by AAEON to prevent system malfunction or
 fires.
- 3. Make sure the power source matches the power rating of the device.
- 4. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- 5. Always completely disconnect the power before working on the system's hardware.
- 6. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
- 7. If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
- 8. Always disconnect this device from any AC supply before cleaning.
- 9. While cleaning, use a damp cloth instead of liquid or spray detergents.
- 10. Make sure the device is installed near a power outlet and is easily accessible.
- 11. Keep this device away from humidity.
- 12. Place the device on a solid surface during installation to prevent falls
- 13. Do not cover the openings on the device to ensure optimal heat dissipation.
- 14. Watch out for high temperatures when the system is running.
- 15. Do not touch the heat sink or heat spreader when the system is running
- 16. Never pour any liquid into the openings. This could cause fire or electric shock.

Preface VI

- 17. As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and contain all electronic components in any static-shielded containers.
- 18. If any of the following situations arises, please the contact our service personnel:
 - i. Damaged power cord or plug
 - ii. Liquid intrusion to the device
 - iii. Exposure to moisture
 - iv. Device is not working as expected or in a manner as described in this manual
 - v. The device is dropped or damaged
 - vi. Any obvious signs of damage displayed on the device
- 19. DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

Preface VII



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

Preface VIII

产品中有毒有害物质或元素名称及含量

AAEON System

QO4-381 Rev.A0

| | 有毒有害物质或元素 | | | | | |
|------------------|-----------|------|------|----------|---------|------------|
| 部件名称 | 铅 | 汞 | 镉 | 六价铬 | 多溴联苯 | 多溴二苯 |
| | (Pb) | (Hg) | (Cd) | (Cr(VI)) | (PBB) | 醚(PBDE) |
| 印刷电路板 | × | 0 | 0 | 0 | \circ | \circ |
| 及其电子组件 | × | O | O | 0 | O | |
| 外部信 号 | × | 0 | 0 | 0 | \circ | \circ |
| 连接器及线材 | × | O | O | 0 | O | |
| 外壳 | 0 | 0 | 0 | 0 | 0 | 0 |
| 中央处理器 | × | 0 | 0 | 0 | \circ | \bigcirc |
| 与内存 | × | | O | O | O | |
| 硬盘 | × | 0 | 0 | 0 | 0 | 0 |
| 液晶模块 | × | × | 0 | 0 | 0 | 0 |
| 光驱 | × | 0 | 0 | 0 | 0 | 0 |
| 触控模块 | × | 0 | 0 | 0 | 0 | 0 |
| 电源 | × | 0 | 0 | 0 | 0 | 0 |
| 电池 | × | 0 | 0 | 0 | 0 | 0 |
| 电池 | | 0 | 0 | 0 | 0 | 0 |

本表格依据 SJ/T 11364 的规定编制。

- 〇:表示该有毒有害物质在该部件所有均质材料中的含量均在 GB/T 26572标准规定的限量要求以下。
- ×: 表示该有害物质的某一均质材料超出了GB/T 26572的限量要求,然而该部件

仍符合欧盟指令2011/65/EU 的规范。

备注:

- 一、此产品所标示之环保使用期限,系指在一般正常使用状况下。
- 二、上述部件物质中央处理器、内存、硬盘、光驱、电源为选购品。
- 三、上述部件物质液晶模块、触控模块仅一体机产品适用。

Preface IX

Hazardous and Toxic Materials List

AAEON System

QO4-381 Rev.A0

| | Hazardous or Toxic Materials or Elements | | | | | |
|--|--|-----------------|-----------------|------------------------------------|--|--|
| Component Name | Lead (Pb) | Mercury (Hg) | Cadmium (Cd) | Hexavalent Chromium (Cr(VI)) | Polybrominat ed biphenyls (PBBs) | Polybrominat ed diphenyl ethers (PBDEs) |
| PCB and Components | Х | 0 | 0 | 0 | 0 | 0 |
| Wires & Connectors for Ext.Connections | Х | 0 | 0 | 0 | 0 | 0 |
| Chassis | 0 | 0 | 0 | 0 | 0 | 0 |
| CPU & RAM | Χ | 0 | 0 | 0 | 0 | 0 |
| HDD Drive | Χ | 0 | 0 | 0 | 0 | 0 |
| LCD Module | Χ | Χ | 0 | 0 | 0 | 0 |
| Optical Drive | Χ | 0 | 0 | 0 | 0 | 0 |
| Touch Control Module | Х | 0 | 0 | 0 | 0 | 0 |
| PSU | Χ | 0 | 0 | 0 | 0 | 0 |
| Battery | Χ | 0 | 0 | 0 | 0 | 0 |

This form is prepared in compliance with the provisions of SJ/T 11364.

- O: The level of toxic or hazardous materials present in this component and its parts is below the limit specified by GB/T 26572.
- X: The level of toxic of hazardous materials present in the component exceed the limits specified by GB/T 26572, but is still in compliance with EU Directive 2011/65/EU (RoHS 2).

Notes:

- 1. The Environment Friendly Use Period indicated by labelling on this product is applicable only to use under normal conditions.
- 2. Individual components including the CPU, RAM/memory, HDD, optical drive, and PSU are optional.
- 3. LCD Module and Touch Control Module only applies to certain products which feature these components.

Preface X

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Chapter 1

Product Specifications

1.1 Specifications

| System | |
|--------------------|---|
| Processor | Rockchip™ RK3568 Quad-Core Arm® Cortex®-A55 |
| | Processor |
| System Memory | LPDDR4 2GB/4GB (Optional) |
| LCD/CRT Controller | _ |
| Ethernet | 10/100/1000 Base TX x2 |
| I/O Port | LAN x 2 |
| | COM x 2 |
| | USB 3.2 Gen 1 (Type-C OTG) x 1 (For System Recovery) |
| | USB 3.2 Gen 1 x 2 |
| | USB 2.0 x 2 |
| | HDMI x 1 |
| | Audio x 1 |
| Storage Disk Drive | 16GB eMMC and Micro SD card |
| Expansion Slot | Full-size mini-PCle Slot x 1 (PCle 3.0 [x1] or mSATA) |
| OS Support | Android™ 12/Debian |
| | |

| Mechanical | |
|------------------|---|
| Construction | Aluminum Front Bezel + Metal Chassis |
| Mounting | VESA/Panel Mount |
| Dimensions | 7.7" x 5.3" x 1.5" (196.5mm x 135mm x 40mm) |
| Carton Dimension | 11.0" x 8.7" x 6.1" (280mm x 220mm x 154mm) |
| Gross Weight | 2.2 lb. (1Kg) |

Environmental

Operating Temperature $23^{\circ}F \sim 131^{\circ}F (-5^{\circ}C \sim 50^{\circ}C)$ with 0.5 m/s airflow

Storage Temperature $-4^{\circ}F \sim 140^{\circ}F (-20^{\circ}C \sim 60^{\circ}C)$

Storage Humidity 90% @40°C; non-condensing

Vibration 1Grms / 5~ 500Hz / operation

Shock 15 G peak acceleration (11 msec. duration)

EMC CE/FCC Class A

Power Supply

DC Input DC 12V ~ 24V

LCD

Display Type 7" WSVGA (1024 x 600) Color TFT LCD Display

Max Resolution 1024 x 600

Max. Colors 16.7M

Luminance 320 nits

Viewing Angle 145° (H); 150° (V)

Back Light LED

Back Light MTBF (Hours) 25,000

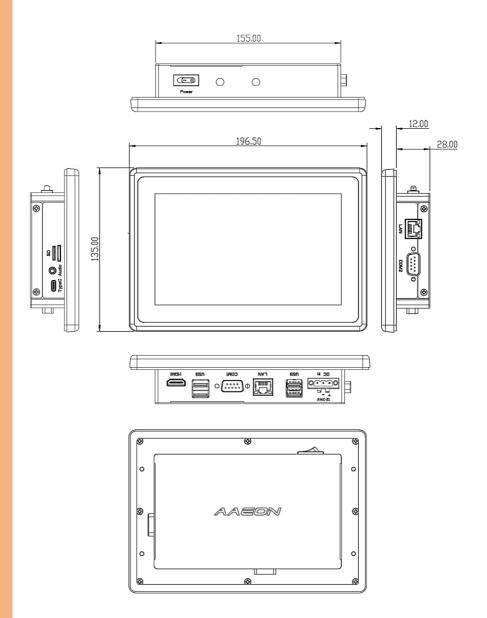
Touchscreen

Type Projected Capacitive Multi-Touch

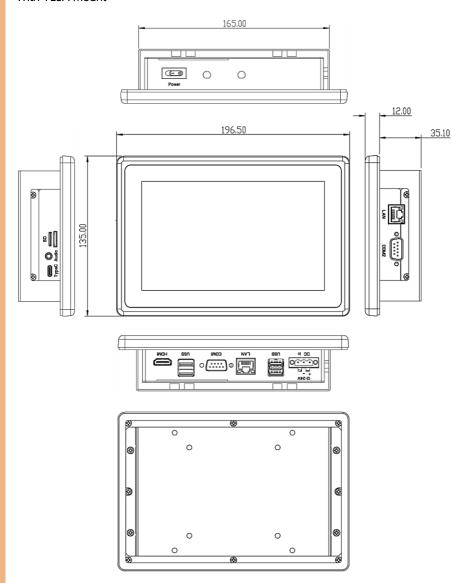
Light Transmission 90%

Chapter 2

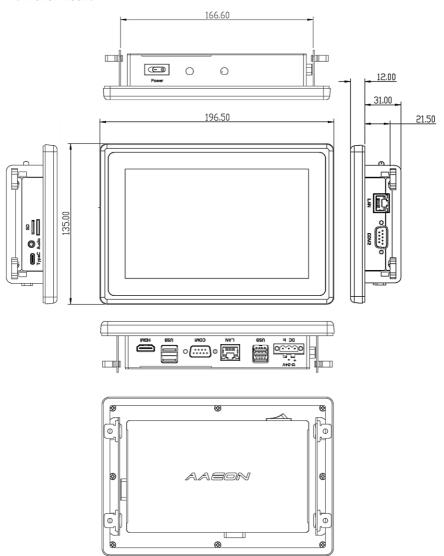
Hardware Information



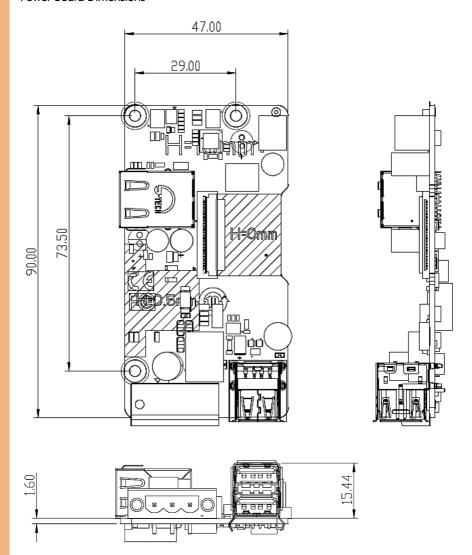
With VESA Mount

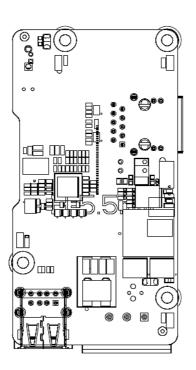


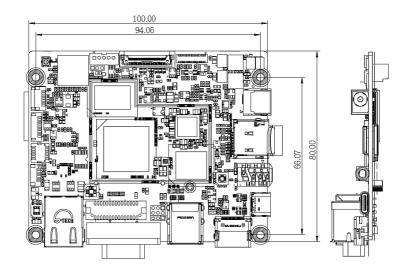
With Panel Mount

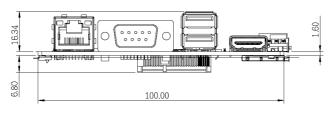


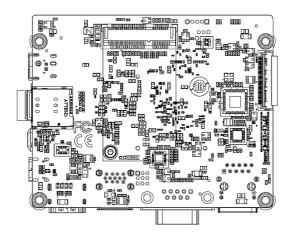
Power Board Dimensions



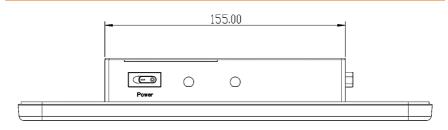






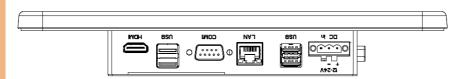


2.2.1 Upper Side View

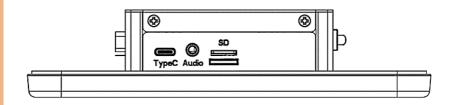


| Function | |
|----------|---|
| Power | Power Switch. Press for 2 seconds to turn ON/OFF. |

2.2.2 Bottom Side View

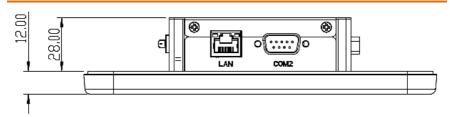


| Function | | |
|----------|---|--|
| HDMI | HDMI Type-A Port for HDMI Cable | |
| USB | USB Type-A Port for USB 2.0 and USB 3.2 Gen 1 | |
| COM 1 | DB-9 Port for RS-232/422/485 | |
| LAN | Giga LAN Port | |
| DC In | Phoenix Connector for 12V ~ 24V DC Input | |



| Function | |
|----------|---|
| USB | USB 3.2 Gen 1 Type-C OTG Port |
| Audio | 4-pole Audio Jack for Microphone/Earphone |
| SD | Micro SD Card Socket (Push-Push Type) |
| Nano SIM | Nano SIM Card Socket (Push-Push Type with Tray) |

2.2.4 Right Hand Side View



| Function | |
|----------|----------------------|
| LAN* | Giga LAN Port |
| COM 2 | DB-9 Port for RS-232 |

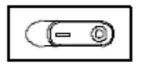
Note: This port supports Wide Area Network (WAN) with Debian OS.

Note: This port only supports Local area network (LAN) with Android OS.

2.3 List of Connectors

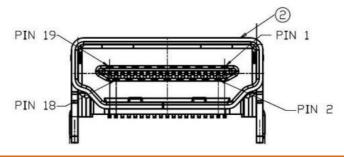
Please refer to the table below for all of the board's connectors that you can configure for your application

| Connector List |
|----------------------------|
| Power Button: On/Off |
| HDMI Port |
| USB 3.2 Gen 1/USB 2.0 Port |
| COM Port |
| RJ-45 LAN Port |
| USB 3.2 Gen 1 Type-C OTG |
| Audio Jack w/ Mic Function |
| Nano SIM Card |



POWER

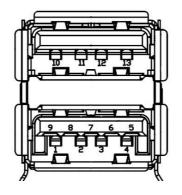
2.3.2 HDMI Port



| Pin | Pin Name | Signal Type | Signal Level |
|-----|----------------|-------------|--------------|
| 1 | HDMI_TX2P_CONN | DIFF | |
| 2 | GND | GND | GND |
| 3 | HDMI_TX2N_CONN | DIFF | |
| 4 | HDMI_TX1P_CONN | DIFF | |
| 5 | GND | GND | GND |
| 6 | HDMI_TX1N_CONN | DIFF | |
| 7 | HDMI_TX0P_CONN | DIFF | |
| 8 | GND | GND | GND |
| 9 | HDMI_TX0N_CONN | DIFF | |
| 10 | HDMI_TXCP_CONN | DIFF | |
| 11 | GND | GND | GND |
| 12 | HDMI_TXCN_CONN | DIFF | |
| 13 | PORT_CEC | OUT | |
| 14 | N.C. | N/A | N/A |
| 15 | HDMI_SCL | I/O | |
| 16 | HDMI_SDA | I/O | |

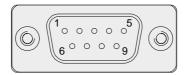
| Pin | Pin Name | Signal Type | Signal Level | |
|-----|------------|-------------|--------------|--|
| 17 | GND | GND | GND | |
| 18 | VCC5V_HDMI | PWR | +5V | |
| 19 | PORT_HPD | IN | | |

2.3.3 USB 3.2 Gen 1/USB 2.0 Port



| Pin | Pin Name | Signal Type | Signal Level |
|-----|--------------|-------------|--------------|
| 1 | 5V_USB_C | PWR | +5V |
| 2 | USB3_DM_C | DIFF | |
| 3 | USB3_DP_C | DIFF | |
| 4 | GND | GND | GND |
| 5 | USB3_SSRXN_C | DIFF | |
| 6 | USB3_SSRXP_C | DIFF | |
| 7 | GND | GND | GND |
| 8 | USB3_SSTXN_C | DIFF | |
| 9 | USB3_SSTXP_C | DIFF | |
| 10 | 5V_USB_C | PWR | +5V |
| 11 | USB2_N_C | DIFF | |
| 12 | USB2_P_C | DIFF | |
| 13 | GND | GND | GND |

Note: The driving current of 5V_USB_C supports up to 2A.

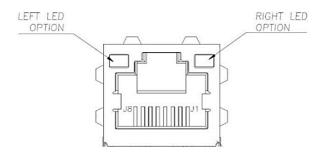


| RS-232 | | | | |
|--------|-------------|-------------|--------------|--|
| Pin | Pin Name | Signal Type | Signal Level | |
| 1 | DCD | IN | | |
| 2 | RX | IN | | |
| 3 | TX | OUT | +10V | |
| 4 | DTR | OUT | +10V | |
| 5 | GND | GND | GND | |
| 6 | DSR | IN | | |
| 7 | RTS | OUT | +10V | |
| 8 | CTS | IN | | |
| 9 | RI/+5V/+12V | IN/ PWR | +5V/+12V | |

| | | RS-485 | |
|-----|----------|-------------|--------------|
| Pin | Pin Name | Signal Type | Signal Level |
| 5 | GND | GND | GND |
| 1 | RS485_D- | I/O | +5V |
| 2 | RS485_D+ | I/O | +5V |

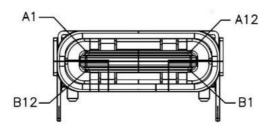
| | | RS-422 | |
|-----|-----------|-------------|--------------|
| Pin | Pin Name | Signal Type | Signal Level |
| 5 | GND | GND | GND |
| 1 | RS422_TX- | OUT | ±5V |
| 2 | RS422_TX+ | OUT | ±5V |
| 3 | RS422_RX+ | IN | |
| 4 | RS422_RX- | IN | |

Note: COM RS-232/422/485 mode can be set by APP settings. Default is RS-232.



| Pin | Pin Name | Signal Type | Signal Level |
|-----|-------------|-------------|--------------|
| _J1 | LAN1_MDI0_P | DIFF | |
| J2 | LAN1_MDI0_N | DIFF | |
| J3 | LAN1_MDI1_P | DIFF | |
| J4 | LAN1_MDI1_N | DIFF | |
| J5 | LAN1_MDI2_P | DIFF | |
| J6 | LAN1_MDI2_N | DIFF | |
| J7 | LAN1_MDI3_P | DIFF | |
| J8 | LAN1_MDI3_N | DIFF | |

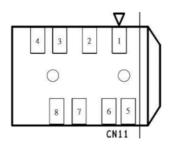
| LED Color | | Link Speed |
|-----------|--------|------------|
| Left | Right | - |
| OFF | Orange | 10 Mbps |
| OFF | Green | 100 Mbps |
| Yellow | OFF | 1000 Mbps |



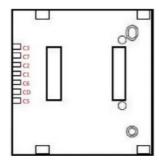
| Pin | Pin Name | Signal Type | Signal Level |
|-----|---------------|-------------|--------------|
| A1 | GND | GND | GND |
| A2 | TYPEC0_TX1P_C | DIFF | |
| A3 | TYPEC0_TX1N_C | DIFF | |
| A4 | VBUS_TYPEC | PWR | |
| A5 | TYPEC_CC1 | I/O | |
| A6 | TYPECO_DP_C | DIFF | |
| A7 | TYPECO_DM_C | DIFF | |
| A8 | N.C. | N/A | N/A |
| A9 | VBUS_TYPEC | PWR | |
| A10 | TYPECO_RX2N_C | DIFF | |
| A11 | TYPEC0_RX2P_C | DIFF | |
| A12 | GND | GND | GND |
| B1 | GND | GND | GND |
| B2 | TYPECO_TX2P_C | DIFF | |
| B3 | TYPEC0_TX2N_C | DIFF | |
| B4 | VBUS_TYPEC | PWR | |
| B5 | TYPEC_CC2 | I/O | |
| B6 | TYPECO_DP_C | DIFF | |
| В7 | TYPECO_DM_C | DIFF | |
| B8 | N.C. | N/A | N/A |
| B9 | VBUS_TYPEC | PWR | |
| B10 | TYPECO_RX1N_C | DIFF | |
| B11 | TYPECO_RX1P_C | DIFF | |
| B12 | GND | GND | GND |

Note: The driving current of VBUS_TYPEC supports up to 2A.

2.3.7 Audio Jack w/ Mic Function



| Pin | Pin Name | Signal Type | Signal Level |
|-----|----------|-------------|--------------|
| _1 | GND | GND | |
| 2 | HP_DET | IN | |
| 3 | HP_J_R | OUT | |
| 4 | N.C. | N/A | N/A |
| 5 | N.C. | N/A | N/A |
| 6 | HP_MIC1N | IN | |
| 7 | N.C. | N/A | N/A |
| 8 | HP_J_L | OUT | |



| Pin | Pin Name | Signal Type | Signal Level |
|-----|-------------|-------------|--------------|
| _C3 | USIM_CLK | IN | |
| C7 | USIM_DATA | 1/0 | |
| C2 | USIM_RESET | IN | |
| C1 | USIM_PWR | PWR | |
| C6 | N.C. | N/A | |
| CD | Card Detect | IN | |
| C5 | GND | GND | GND |